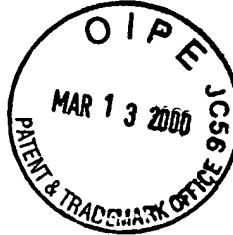


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**CERTIFICATE OF MAILING**

I hereby certify that this paper and every paper referred to therein as being enclosed is being deposited with the U.S. Postal Service as first class mail, postage prepaid, in an envelope addressed to: Commissioner of Patents & Trademarks, Washington DC 20231, on March 9, 2000 (Deposit)  
3/9/00 Date A. DiLullo Name

Docket No.: 1298/0F374



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of: Sailesh CHITTIPEDDI and Sailesh Mansinh MERCHANT

Serial No.: 09/467,253 Art Unit: 2811

Filed: 12/20/99 Examiner:

For: WIRE BONDING METHOD FOR COPPER INTERCONNECTS IN SEMICONDUCTOR DEVICES

Hon. Commissioner of  
Patents and Trademarks  
Washington, DC 20231

Sir:

**COMPLETION OF PATENT APPLICATION**

The following items are submitted herewith in completion of the above-identified patent application:

1. Declaration, petition and power of attorney
2. Please charge the amount of \$ 170.00, (\$130.00 filing; \$40.00 recording) to **LUCENT TECHNOLOGIES, INC. DEPOSIT ACCOUNT NO. 12-2325**
3. ☒ Assignment for recording to: Lucent Technologies Inc.
4. A copy of Notice to File Missing Parts of Application.


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The Patent Office is authorized to charge any deficiency up to \$300.00 in the above fees, and to credit any excess, to **LUCENT TECHNOLOGIES, INC.**  
**DEPOSIT ACCOUNT NO. 12-2325**

Respectfully submitted,

Dated: March 9, 2000

  
Ya-Chiao Chang  
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Serial No. 09/467,253

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